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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

Date Submitted: August 13, 2001

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Sheet 1 of 3

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| Application Number | To Be Assigned | - Z | | | |
| Filing Dat | August 13, 2001 | 5.0 | | | |
| First Nam d Inv ntor | Andrew J. WALKER et al | ~ = 5 | | | |
| Group Art Unit | Unassigned 2827 | 511 | | | |
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| Attorney Docket Number | 035905/0103 | | | | |
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| Filing Dat | 08/13/2001 | | | |
| First Named Inventor | Andrew J. WALKER et al. | | | |
| Group Art Unit | 2818 2829 | | | |
| Examiner Name | Unassigned Pert | | | |
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